

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

APPLICANT: Howard Hao Chen et al. EXAMINER: Brook Kebede
 SERIAL NO.: 10/661,299 GROUP ART UNIT: 2823
 FILED: September 12, 2003
 FOR: COOLING SYSTEM FOR A SEMICONDUCTOR DEVICE AND
 METHOD OF FABRICATING SAME

Mail Stop Amendment
 Commissioner for Patents
 P.O. Box 1450
 Alexandria, VA 22313-1450

AMENDMENT AND RESPONSE TO OFFICE ACTION

Sir:

This paper is submitted in response to the May 17, 2005 Office Action issued by the United States Patent and Trademark Office in connection with the above-identified application. A response to the May 17, 2005 Office Action is due on August 17, 2005. Therefore, this paper is being timely filed.

CERTIFICATE OF MAILING 37 C.F.R. § 1.8(a)

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail, postpaid in an envelope, addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on August 17, 2005.

Dated: August 17, 2005


 Michael F. Morano